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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



January 2005

SEMICONDUCTOR®

AIRCHILD

FDW9926NZ

Common Drain N-Channel 2.5V specified PowerTrench[®] MOSFET

General Description

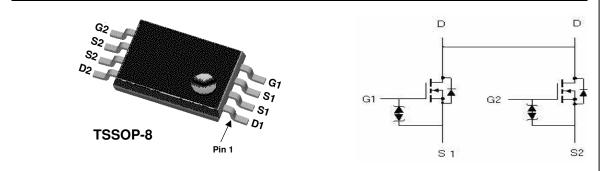
This N-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild's Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 10V).

Applications

- Battery protection
- Load switch
- Power management

Features

- 4.5 A, 20 V. $R_{DS(ON)} = 32 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$ $R_{DS(ON)} = 45 \text{ m}\Omega @ V_{GS} = 2.5 \text{ V}$
- ESD protection diode (note 3)
- High performance trench technology for extremely low $R_{DS(ON)}$ @ V_{GS} = 2.5 V
- Low profile TSSOP-8 package



Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units		
V _{DSS}	Drain-Source	rce Voltage		20	V	
V _{GSS}	Gate-Sourc	urce Voltage		±12	V	
ID	Drain Curre	nt – Continuous	(Note 1a)	4.5	А	
		 Pulsed 		30		
PD	Total Power	r Dissipation	(Note 1a)	1.6	W	
			(Note 1b)	1.1		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	
Therma	I Charac	teristics				
R _{0JA}	Thermal Resistance, Junction-to-Ambient (Note 1a)		Dient (Note 1a)	77	°C/W	
			(Note 1b)	114		
Packag	e Markin	g and Ordering I	Information			
Device		Device	Reel Size	Tape width	Quantity	
9926NZ I		FDW9926NZ	13"	12mm	2500 units	

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
- Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C	20	15		mV/°C
ΔT_J IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 16 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate–Body Leakage	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
		103 = 1, 103 • 1				P# 1
	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.6	1	1.5	V
$\Delta V_{GS(th)}$ $\Delta T_{.1}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3.1		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = 4.5 \ V, & I_D = 4.5 \ A \\ V_{GS} = 2.5 \ V, & I_D = 3.8 \ A \\ V_{GS} = 4.5 \ V, & I_D = 4.5 A, \ T_J = 125^\circ C \end{array} $		27 38 36	32 45 49	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 4.5 A$		22		S
Dynamic	Characteristics	•				
C _{iss}	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		600		pF
Coss	Output Capacitance	f = 1.0 MHz		160		pF
C _{rss}	Reverse Transfer Capacitance			90		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$		1.4		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 V$, $I_D = 1 A$,		8	16	ns
t _r	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$		8	16	ns
t _{d(off)}	Turn–Off Delay Time			14	26	ns
t _f	Turn–Off Fall Time			4	8	ns
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, \qquad I_D = 4.5 \text{ A},$		5.7	8	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		1.3		nC
Q _{gd}	Gate-Drain Charge			1.7		nC
Drain-Sc	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Sourc				0.83	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \ V, ~~I_S = 0.83 \ A ~~(\text{Note 2})$		0.7	1.2	V
t _{rr}	Diode Reverse Recovery Time	I _F = 4.5 A,		16		nS
Q _{rr}	Diode Reverse Recovery Charge	$d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$		5		nC

Notes:

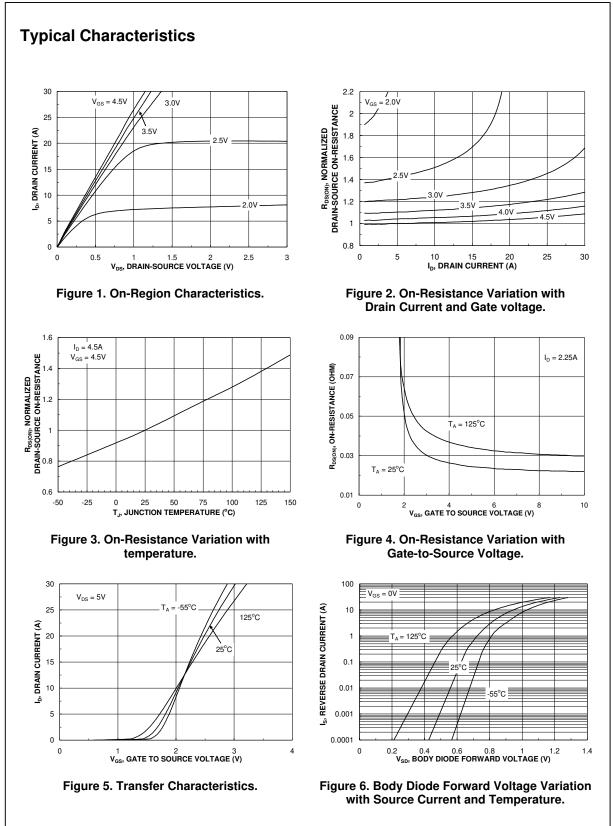
1. R_{6JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $\rm R_{\theta JC}$ is guaranteed by design while $\rm R_{\theta CA}$ is determined by the user's board design.

a) R_{θ,JA} is 77°C/W (steady state) when mounted on a 1 inch² copper pad on FR-4. b) R_{θ,JA} is 114 °C/W (steady state) when mounted on a minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

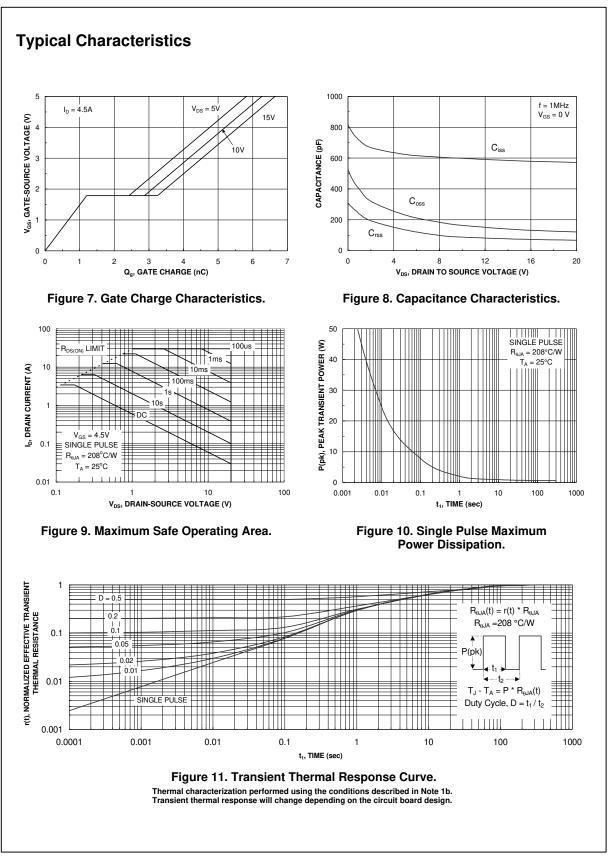
3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

FDW9926NZ



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FDW9926NZ Rev. D(W)



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